

SEMiX302GB066HDs



SEMiX[®]2s

Trench IGBT Modules

SEMiX302GB066HDs

Preliminary Data

Features

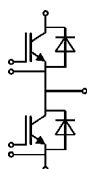
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- UL recognised file no. E63532

Typical Applications

- Matrix Converter
- Resonant Inverter
- Current Source Inverter

Remarks

- Case temperature limited to $T_C=125^\circ\text{C}$ max.
- Product reliability results are valid for $T_j=150^\circ\text{C}$
- For short circuit: Soft R_{Goff} recommended
- Take care of over-voltage caused by stray inductance



GB

Absolute Maximum Ratings				
Symbol	Conditions	Values	Unit	
IGBT				
V_{CES}		600	V	
I_C	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	379	A
		$T_c = 80^\circ\text{C}$	286	A
I_{Cnom}		300	A	
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	600	A	
V_{GES}		-20 ... 20	V	
t_{psc}	$V_{CC} = 360\text{ V}$		6	μs
	$V_{GE} \leq 15\text{ V}$			
	$T_j = 150^\circ\text{C}$			
	$V_{CES} \leq 600\text{ V}$			
T_j		-40 ... 175	$^\circ\text{C}$	
Inverse diode				
I_F	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	419	A
		$T_c = 80^\circ\text{C}$	307	A
I_{Fnom}		300	A	
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	600	A	
I_{FSM}	$t_p = 10\text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$	1400	A	
T_j		-40 ... 175	$^\circ\text{C}$	
Module				
$I_{t(RMS)}$		600	A	
T_{stg}		-40 ... 125	$^\circ\text{C}$	
V_{isol}	AC sinus 50Hz, $t = 1\text{ min}$	4000	V	

Characteristics						
Symbol	Conditions	min.	typ.	max.	Unit	
IGBT						
$V_{CE(sat)}$	$I_C = 300\text{ A}$ $V_{GE} = 15\text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	1.45	1.9	V	
		$T_j = 150^\circ\text{C}$	1.70	2.1	V	
V_{CE0}		$T_j = 25^\circ\text{C}$	0.9	1	V	
		$T_j = 150^\circ\text{C}$	0.85	0.9	V	
r_{CE}	$V_{GE} = 15\text{ V}$	$T_j = 25^\circ\text{C}$	1.8	3.0	$\text{m}\Omega$	
		$T_j = 150^\circ\text{C}$	2.8	4.0	$\text{m}\Omega$	
$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C = 4.8\text{ mA}$	5	5.8	6.5	V	
I_{CES}	$V_{GE} = 0\text{ V}$ $V_{CE} = 600\text{ V}$	$T_j = 25^\circ\text{C}$	0.15	0.45	mA	
		$T_j = 150^\circ\text{C}$			mA	
C_{ies}	$V_{CE} = 25\text{ V}$ $V_{GE} = 0\text{ V}$	$f = 1\text{ MHz}$	18.5	nF		
C_{oes}		$f = 1\text{ MHz}$	1.15	nF		
C_{res}		$f = 1\text{ MHz}$	0.55	nF		
Q_G	$V_{GE} = -8\text{ V...}+15\text{ V}$		2400	nC		
R_{Gint}	$T_j = 25^\circ\text{C}$		1.00	Ω		
$t_{d(on)}$	$V_{CC} = 300\text{ V}$		110	ns		
t_r	$I_C = 300\text{ A}$		85	ns		
E_{on}	$T_j = 150^\circ\text{C}$		11.5	mJ		
$t_{d(off)}$	$R_{G on} = 5.1\ \Omega$		820	ns		
t_f	$R_{G off} = 5.1\ \Omega$		70	ns		
E_{off}			15	mJ		
$R_{th(j-c)}$	per IGBT			0.16	K/W	



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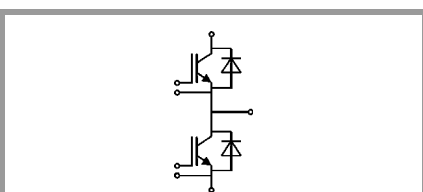
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Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
$V_F = V_{EC}$	$I_F = 300\text{ A}$ $V_{GE} = 0\text{ V}$ chipllevel	$T_j = 25^\circ\text{C}$		1.4	1.6	V
		$T_j = 150^\circ\text{C}$		1.4	1.6	V
V_{F0}		$T_j = 25^\circ\text{C}$	0.9	1	1.1	V
		$T_j = 150^\circ\text{C}$	0.75	0.85	0.95	V
r_F		$T_j = 25^\circ\text{C}$	1.0	1.3	1.7	m Ω
		$T_j = 150^\circ\text{C}$	1.5	1.8	2.2	m Ω
I_{RRM}	$I_F = 300\text{ A}$	$T_j = 150^\circ\text{C}$		240		A
Q_{rr}	$di/dt_{off} = 3600\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		35		μC
E_{rr}	$V_{GE} = -8\text{ V}$ $V_{CC} = 300\text{ V}$	$T_j = 150^\circ\text{C}$		7.5		mJ
$R_{th(j-c)}$	per diode				0.19	K/W
Module						
L_{CE}				18		nH
$R_{CC'+EE'}$	res., terminal-chip	$T_C = 25^\circ\text{C}$		0.7		m Ω
		$T_C = 125^\circ\text{C}$		1		m Ω
$R_{th(c-s)}$	per module			0.045		K/W
M_s	to heat sink (M5)		3		5	Nm
M_t	to terminals (M6)		2.5		5	Nm
w					250	g
Temperature sensor						
R_{100}	$T_C=100^\circ\text{C}$ ($R_{25}=5\text{ k}\Omega$)			0,493 $\pm 5\%$		k Ω
$B_{100/125}$	$R_{(T)}=R_{100}\exp[B_{100/125}(1/T-1/T_{100})]$; $T[\text{K}]$;			3550 $\pm 2\%$		K



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